PTO/SB/21 (08-03) 10/680,874 Application Number TRANSMITTAL Filing Date October 6, 2003 **FORM** First Named Inventor Farrens, Sharon N. (to be used for all correspondence after initial filing) **Art Unit** To Be Assigned **Examiner Name** To Be Assigned Total Number of Pages in This 6\* Attorney Docket Number 18419D-009011US Submission(\* and 13 IDS References) ENCLOSURES (Check all that apply) Fee Transmittal Form Drawing(s) After Allowance Communication to Group Appeal Communication to Board of Appeals Fee Attached Licensing-related Papers and Interferences Petition Appeal Communication to Group (Appeal Amendment/Reply Notice, Brief, Reply Brief) Petition to Convert to a **Proprietary Information** After Final Provisional Application Power of Attorney, Revocation Affidavits/declaration(s) Status Letter Change of Correspondence Address Terminal Disclaimer Other Enclosure(s) Extension of Time Request (please identify below): Request for Refund SB08A and SB08B, Thirteen (13) IDS Express Abandonment Request References, Return Postcard CD, Number of CD(s) Information Disclosure Statement The Commissioner is authorized to charge any additional fees to Deposit Certified Copy of Priority Remarks Account 20-1430. Document(s) Response to Missing Parts/ Incomplete Application Response to Missing Parts under 37 CFR 1.52 or 1.53 SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT Firm Townsend and Townsend and Crew LLP Tyrome Y. Brown Reg. No. 46,580 Individual Signature Date January 6, 2004 **CERTIFICATE OF TRANSMISSION/MAILING** I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below.

Date

January 6, 2004

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TOWNSEND and TOWNSEND and CREW LLP

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

JAN 0 8 2004

In re application of:

Sharon N. Farrens et al.

Application No.: 10/680,874

Filed: October 6, 2003

For: IN SITU PLASMA WAFER

**BONDING METHOD** 

Examiner: To Be Assigned

Art Unit: To Be Assigned

INFORMATION DISCLOSURE

STATEMENT UNDER 37 CFR §1.97 and

**§1.98** 

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

The references cited on attached form PTO/SB/08A and PTO/SB/08B are being called to the attention of the Examiner. Copies of the references are enclosed. It is respectfully requested that the cited references be expressly considered during the prosecution of this application, and the references be made of record therein and appear among the "references cited" on any patent to issue therefrom.

As provided for by 37 CFR 1.97(g) and (h), no inference should be made that the information and references cited are prior art merely because they are in this statement and no representation is being made that a search has been conducted or that this statement encompasses all the possible relevant information.

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Applicant believes that <u>no fee is required</u> for submission of this statement. However, if a fee is required, the Commissioner is authorized to deduct such fee from the undersigned's Deposit Account No. 20-1430. Please deduct any additional fees from, or credit any overpayment to, the above-noted Deposit Account.

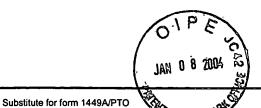
Respectfully submitted,

Tyrome Y. Brown Reg. No. 46,580

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Tel: 650-326-2400 Fax: 650-326-2422

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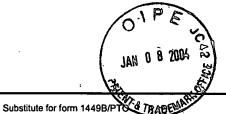
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| Application Number     | 10/680,874         |  |  |
| Filing Date            | October 6, 2003    |  |  |
| First Named Inventor   | Farrens, Sharon N. |  |  |
| Art Unit               | To Be Assigned     |  |  |
| Examiner Name          | To Be Assigned     |  |  |
| Attorney Docket Number | 18419D-009011US    |  |  |

| U.S. PATENT DOCUMENTS+ |              |  |                                |  |   |  |
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| Document               |              | Document Number                          |                                |  |   |  |
| Examiner<br>Initials*  | Cite<br>No.¹ | Number Kind Code <sup>2</sup> (if known) | Publication Date<br>MM-DD-YYYY | Name of Patentee or<br>Applicant of Cited Document | Pages, Columns, Lines, Where<br>Relevant Passages or Relevant<br>Figures Appear |  |
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| Examiner<br>Initials* | Cite<br>No. <sup>1</sup> | Country Code <sup>3</sup> | Number <sup>4</sup> | Kind Code <sup>5</sup> (if known) | Publication Date<br>MM-DD-YYYY | Name of Patentee or<br>Applicant of Cited<br>Document | Where Relevant Passages or Relevant Figures Appear | Τ <sup>6</sup> |
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**INFORMATION DISCLOSURE** STATEMENT BY APPLICANT

Complet if Known Application Number 10/680,874 Filing Date October 6, 2003 First Named Inventor Farrens, Sharon N. Art Unit To Be Assigned Examiner Name To Be Assigned 18419D-009011US Attorney Docket Number

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| Examiner<br>Initials * | Cite<br>No.1                    | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | T² |  |  |
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